

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT4945093

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
GAYATRI V. DADHEECH	05/02/2018
BAHRAM KHALIGHI	05/02/2018
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15970221
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ATTORNEY DOCKET NUMBER:	P044210-US-NP/003.1773US
NAME OF SUBMITTER:	ADITYA KRISHNAN
SIGNATURE:	/ADITYA KRISHNAN/
DATE SIGNED:	05/03/2018
Total Attachments: 1	
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ASSIGNMENT

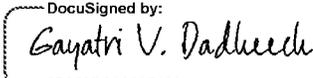
Pursuant to an agreement with my employer, I formally assign to GM GLOBAL TECHNOLOGY OPERATIONS LLC, the entire right, title and interest, in all countries and application types, in the improvements set forth in the United States patent application P044210-US-NP/003.1773US entitled:

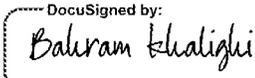
SYSTEMS AND APPARATUSES FOR HIGH PERFORMANCE ATMOSPHERE THIN FILM PIEZOELECTRIC RESONANT PLASMAS TO MODULATE AIR FLOWS

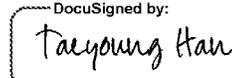
for which application for Letters Patent of the United States:

- has been executed on even date herewith;
- executed on _____;
- was filed on May 3, 2018 and assigned U.S. Serial No. 15/970,221;

ASSIGNOR hereby authorizes GM GLOBAL TECHNOLOGY OPERATIONS LLC, its successors and assigns, its legal representatives, or anyone it may properly designate, to insert in this instrument the filing date and/or serial number of said application when ascertained.

Inventor's signature /  / Date: 5/2/2018
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